

EVIDEN

BullSequana EXR & AI100R

Description Guide

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Hardware

January 2025

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Preface

This guide lists user documentation and provides a general overview of the server.

See The Bull support web site for the most up-to-date product information, documentation, firmware updates, software fixes and service offers:
<https://support.bull.com>

Intended readers

This guide is intended for use by system administrators and operators.

Important user information

Read this document and the other product documents about installation, configuration, operation, and maintenance of the product before installing, configuring, operating or servicing it.

Activities including installation, adjustments, putting into service, use, and maintenance are required to be carried out by suitably trained personnel in accordance with applicable codes of practice.

If the product is used in a manner not specified by the manufacturer, the protection provided by the product may be impaired.



DANGER D049

The product must not be used in life support system or other applications where failure could threaten injury or life, and any such use voids the limited warranty associated to the product.

Regulatory declarations and disclaimers

Safety compliance statement

This product is in compliance with the following:

European Union (EU)

Low voltage directive 2014/35/EU: standard EN 62368-1

UL/CSA certification

UL 62368 (USA)

CSA 62368 (Canada)

Electromagnetic compatibility statement

This product is in compliance with the protection requirements of the following:

European Union (EU)

EMC directive 2014/30/EU : standards EN 55032, EN 55035, EN 61000-3-2, EN 61000-3-3

Federal Communications Commission (FCC) compliance (USA)

CFR 47, FCC Part 15 B

FCC declaration of conformity

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) this device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

FCC statement

This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to Part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

Properly shielded and grounded cables and connectors must be used in order to meet FCC emission limits. Neither the provider nor the manufacturer are responsible for any radio or television interference caused by using other than recommended cables and connectors or by unauthorized changes or modifications to this equipment. Unauthorized changes or modifications could void the user's authority to operate the equipment.

Pursuant to Part 15.21 of the FCC Rules, any changes or modifications to this equipment not expressly approved by the manufacturer may cause harmful interference and void the FCC authorization to operate this equipment. An FCC regulatory label is affixed to the equipment.

ICES-003 compliance (Canada)

Canadian Compliance Statement (Industry Canada)

This Class A digital apparatus meets all requirements of the Canadian Interference Causing Equipment Regulations.

This product is in conformity with the protection requirements of the ICES-003 standard.

Waste management

This product has been built to comply with the following:

REACH

Regulation (EC) N°1907/2006 of the European Parliament and the 18/12/2006 REACH Council

ROHS

2011/65/EU, complemented by the delegated directive 2015/863/UE

WEEE

2012/19/EU

Safety notices

Important **Read the safety notices before undertaking any procedures described in the documentation.**

All safety notices used in the documentation are listed in the Multilingual Safety Notices Guide and are classified by severity:



DANGER D000

A Danger notice indicates the presence of a hazard that has the potential of causing death or serious personal injury.



CAUTION C000

A Caution notice indicates the presence of a hazard that has the potential of causing moderate or minor personal injury.



WARNING W000

A Warning notice indicates an action that could cause damage to a program, device, system, or data.

Each safety notices is prefixed with a unique identification number. This can be used to locate the corresponding translated version in the Multilingual Safety Notices Guide.

Chapter 1. Related publications

This list is not exhaustive. Useful documentation is supplied on the Resource and Documentation ISO file delivered with the system. It is strongly advised to refer carefully to this documentation before proceeding to configure, use, maintain, or update the system.

Documentation Sets

- BullSequana EX & AI Customer Documentation Set, 86 XP 74PA
This documentation set contains all the customer documentation relative to the server.
- BullSequana EX & AI Field Documentation Set, 86 XP 75PA
This documentation set contains all the field documentation relative to the server.

Read me First

- Resource and Documentation ISO file
This ISO file contains the tools and documentation required to configure, operate and maintain the system.
- BullSequana Servers Site Preparation Guide, 86 A1 85FP
This guide explains how to prepare a data processing center for servers, in compliance with the standards in force. This guide is intended for use by all personnel and trade representatives involved in the site preparation process.
- BullSequana Servers Safety Notices Guide, 86 X1 12FL
This guide lists, in different languages, the notices referenced in the documentation procedures.
- BullSequana EXR & AI100R Description Guide, 86 A1 73FS
This guide lists user documentation and provides a general overview of the server. This guide is intended for use by system administrators and operators.

Installation

BullSequana EXR & AI100R Installation Guide, 86 A1 76FS

This guide explains how to install the server for the first time. This guide is intended for use by instructed or skilled personnel in charge of installing the server.

Operation

- BullSequana EX & AI Server Hardware Console (SHC), 86 A1 26FT
This guide explains how to use the SHC to manage the server. This guide is intended for use by system administrators and operators.

- BullSequana Servers MONGUI User's Guide, 86 A1 61FT
This guide explains how to use the MONitoring Graphical User Interface (MONGUI) to manage BullSequana servers.
- BullSequana EX & AI Getting Started Guide, 86 A1 31FT
This guide explains how to set up the server. This guide is intended for use by system administrators and operators.
- BullSequana EX & AI Redfish Documentation, 86 A1 38FT
This guide explains the implementation of the Redfish API for server management. This guide is intended for use by system administrators and operators.
- BullSequana Servers OneBSM Console Reference Guide, 86 A1 55FT
This guide explains how to use the OneBSM console to monitor and maintain Eviden systems. This guide is intended for use by system administrators and operators.

Maintenance

- BullSequana EX & AI Redfish Events Messages, 86 A1 35FT
This guide lists the messages issued by the server and provides associated actions and information to troubleshoot. This guide is intended for use by system administrators and operators.
- BullSequana EXR & AI100R Customer Service Guide, 86 A1 34FT
This guide explains how to replace the Customer Replaceable Units (CRUs) of the server. This guide is intended for use by instructed or skilled personnel in charge of server and cabinet maintenance.
- BullSequana EXR & AI100R Field Service Guide, 86 A7 47FT
This guide explains how to replace the Field Replaceable Units (FRUs) of a server. This guide is intended for use by instructed or skilled personnel in charge of server and cabinet maintenance.

Chapter 2. BullSequana EXR & AI100R description

2.1. Overview

BullSequana EX & AI servers exploit the Intel® Xeon® platform, Sapphire Rapids processor. Each BullSequana EX & AI includes one processor that can support up to eight DDR5 memory modules.

Each BullSequana EXR & AI100R module is 1U high.

Two storage options are available:

- Up to 6 front loaded hot swappable 2.5 inch SATA disk modules
- Up to 8x M.2 NVMe disks are available for storage

In addition two M.2 cards are supported on an internal riser for boot disk, accelerator cards and WIFI communication card options.

A PCIe module supports one double or two single width PCIe cards, including GPU accelerators.

Four wireless technologies are supported:

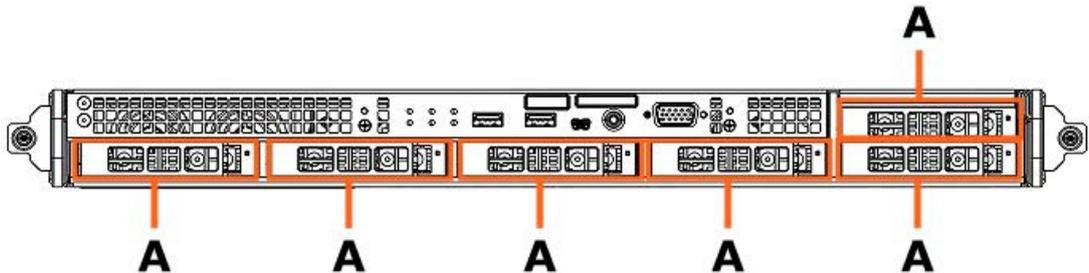
- 2.4 GHz - 5.9 GHz dual-band WiFi (Dual-band WiFi)
- Bluetooth
- Long Term Evolution 5G Global System for Mobile Communications
- LoRa

BullSequana EX & AI servers are air-cooled and managed by a single Baseboard Management Controller (BMC).

2.2. Front components

2.2.1. 2.5 inch SATA disk option

 Front view

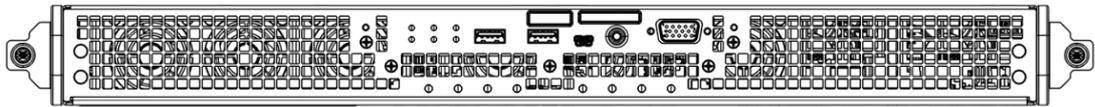


Mark	Description	Quantity
A	2.5 inch SATA disks	6

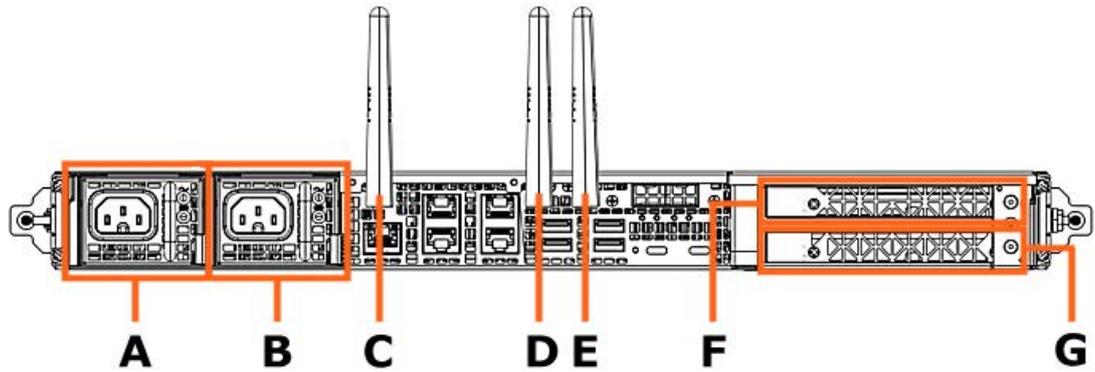
2.2.2. M.2 NVMe disk option

There are no accessible components at the front of the server.

 Front view



2.3. Rear components



Mark	Description
A	PSU 0
B	PSU 1
C	Antenna
D	Antenna
E	Antenna
F	Up to 2 x 150 W or 1 x 300 W PCIe modules
G	

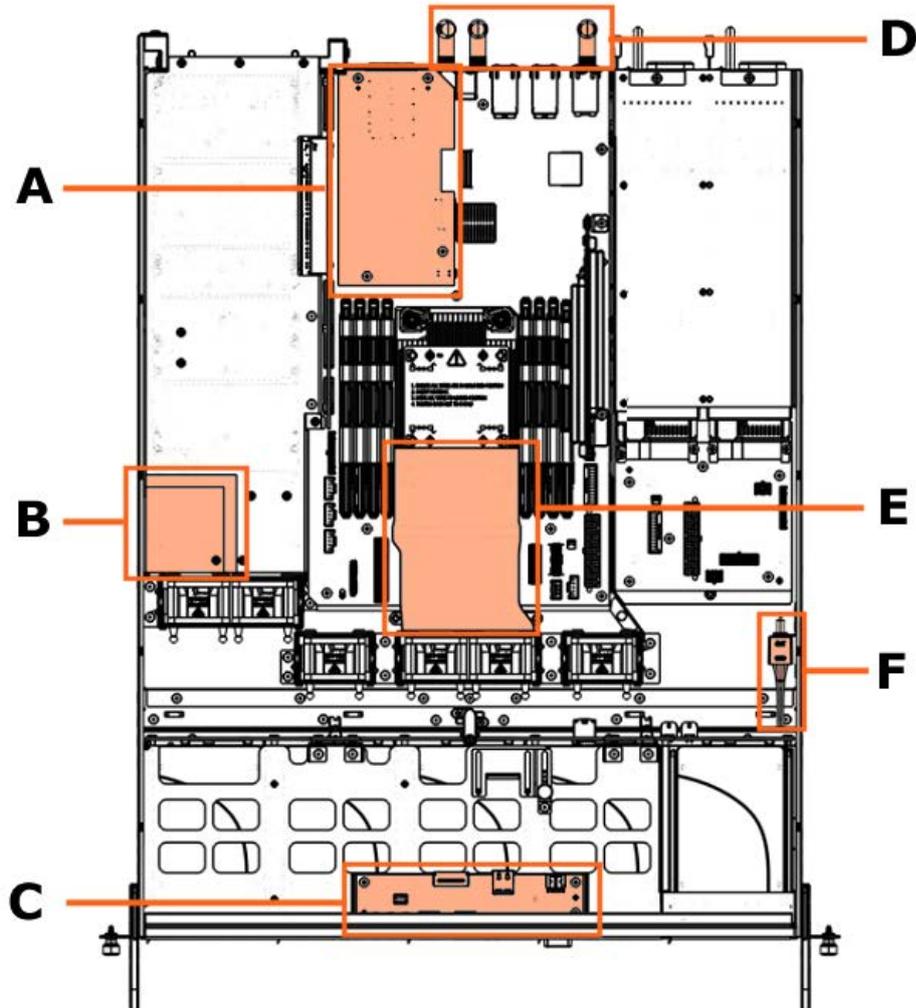
Notes

- The server is equipped with two PSUs (2N redundancy).
- Dual-band 2.4-5.9 GHz WIFI, LoRa, LTE/5G wireless technologies are supported. See the Installation Guide for the different antenna configurations possible.

2.4. Top level components

2.4.1. 2.5 inch SATA disk option

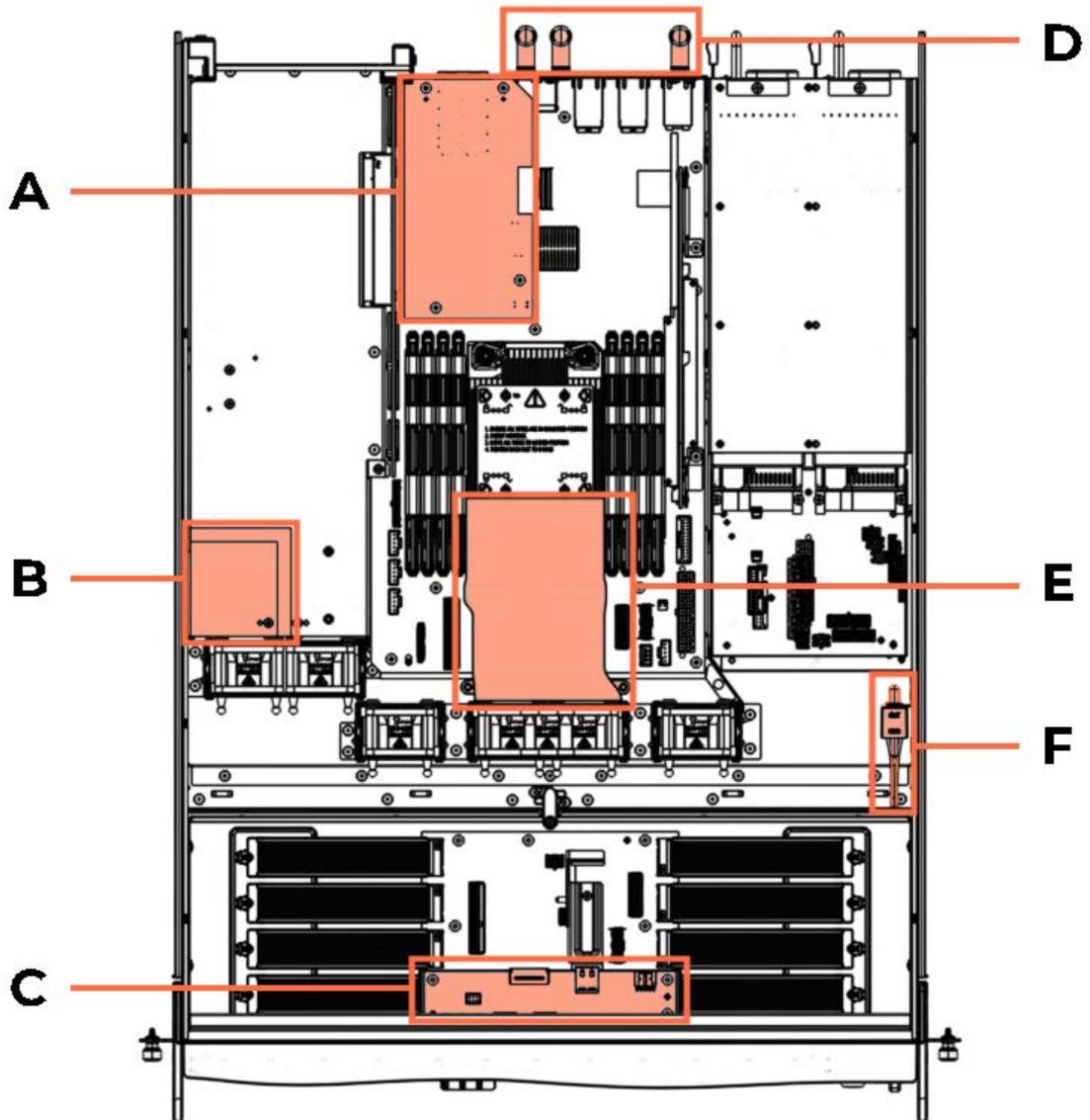
 Top view



Mark	Description	Quantity
A	10 Gb/s mezzanine (optional)	1
B	PCIe air duct	1
C	Front Panel Board (FPB)	1
D	Antennas	Up to 3
E	Processor air duct	1
F	Intrusion detection switch	1

2.4.2. M.2 NVMe disk option

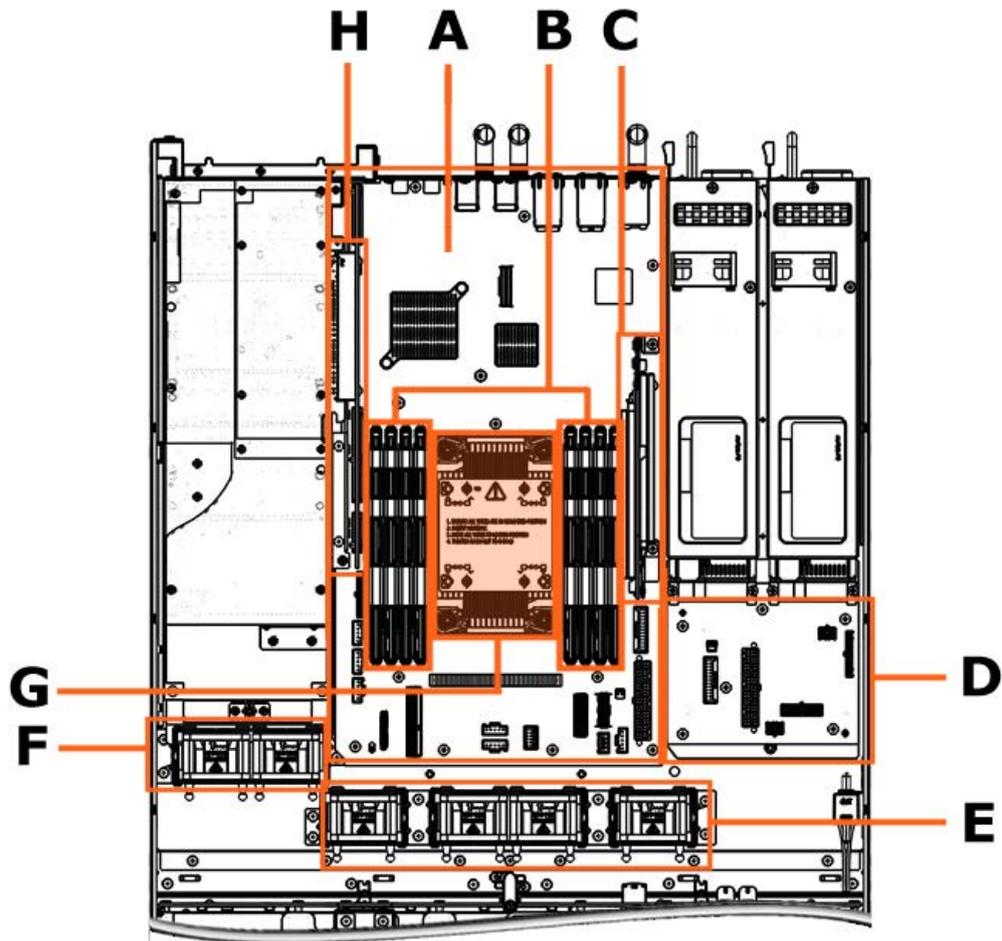
 Top view



Mark	Description	Quantity
A	10 Gb/s mezzanine (optional)	1
B	PCIe air duct	1
C	Front Panel Board (FPB)	1
D	Antennas	Up to 3
E	Processor air duct	1
F	Intrusion detection switch	1

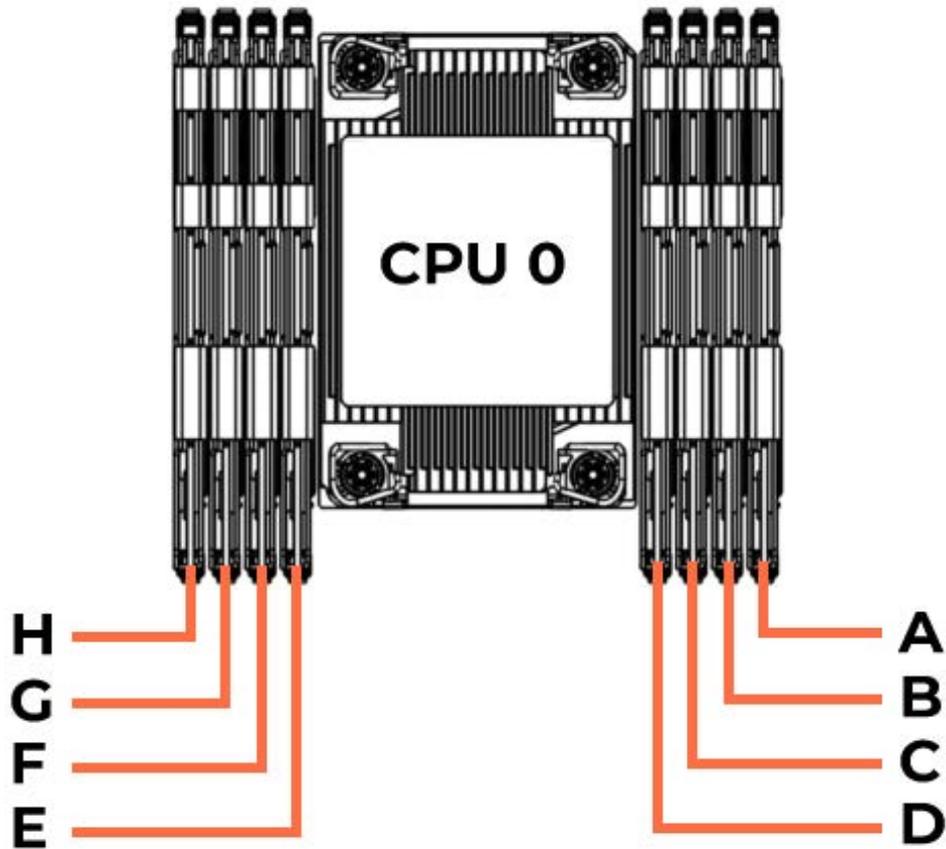
2.5. Base level components

2.5.1. Components



Mark	Description	Quantity
A	Motherboard	1
B	Memory modules	8
C	M.2 riser board	1
D	Power Distribution Board (PDB)	1
E	Motherboard fans	4
F	PCIe fans	2
G	Processor assembly	1
H	PCIe riser board	1

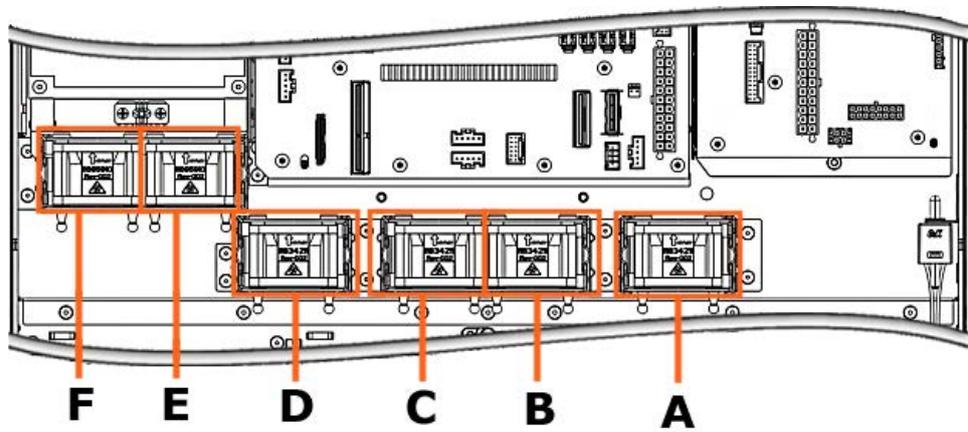
2.5.2. Memory module channels



Mark	iMC	Channel	Board slot	ID	BIOS setup memory topology
H	3	7	CH-H	DIMM-CHH0	Socket0.ChH.Dimm0
G	3	6	CH-G	DIMM-CHG0	Socket0.ChG.Dimm0
F	2	5	CH-F	DIMM-CHF0	Socket0.ChF.Dimm0
E	2	4	CH-E	DIMM-CHE0	Socket0.ChE.Dimm0
A	0	0	CH-A	DIMM-CHA0	Socket0.ChA.Dimm0
B	0	1	CH-B	DIMM-CHB0	Socket0.ChB.Dimm0
C	1	2	CH-C	DIMM-CHC0	Socket0.ChC.Dimm0
D	1	3	CH-D	DIMM-CHD0	Socket0.ChD.Dimm0

2.5.3. Fans

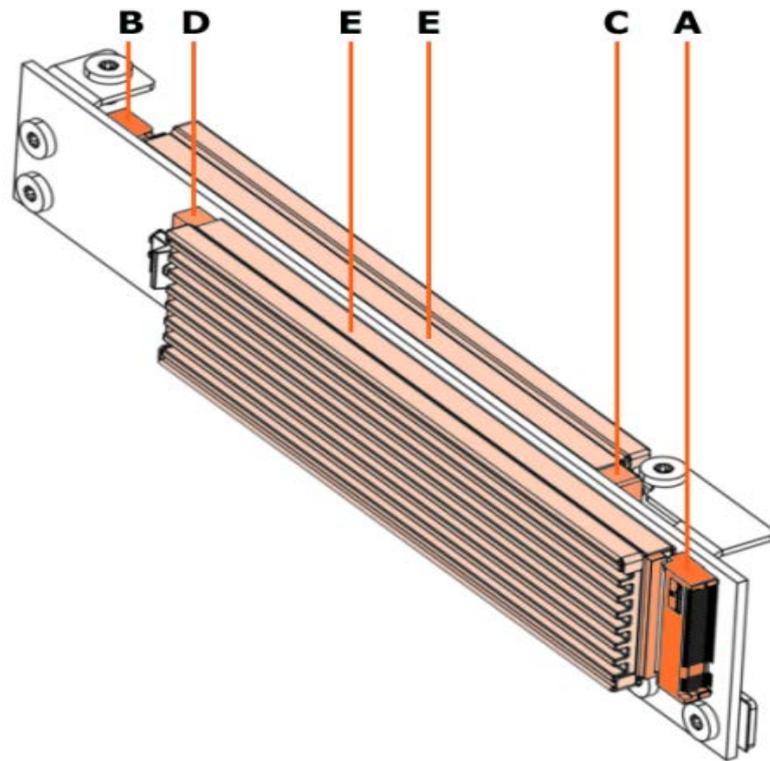
 Top view



Mark	Description		
A	Motherboard fans	Single fan	FAN 0
B		Processor fans	FAN 1
C			FAN 2
D		Single fan	FAN 3
E	PCIe fans		FAN 4
F			FAN 5

2.5.4. M.2 riser board

M.2 type M riser board

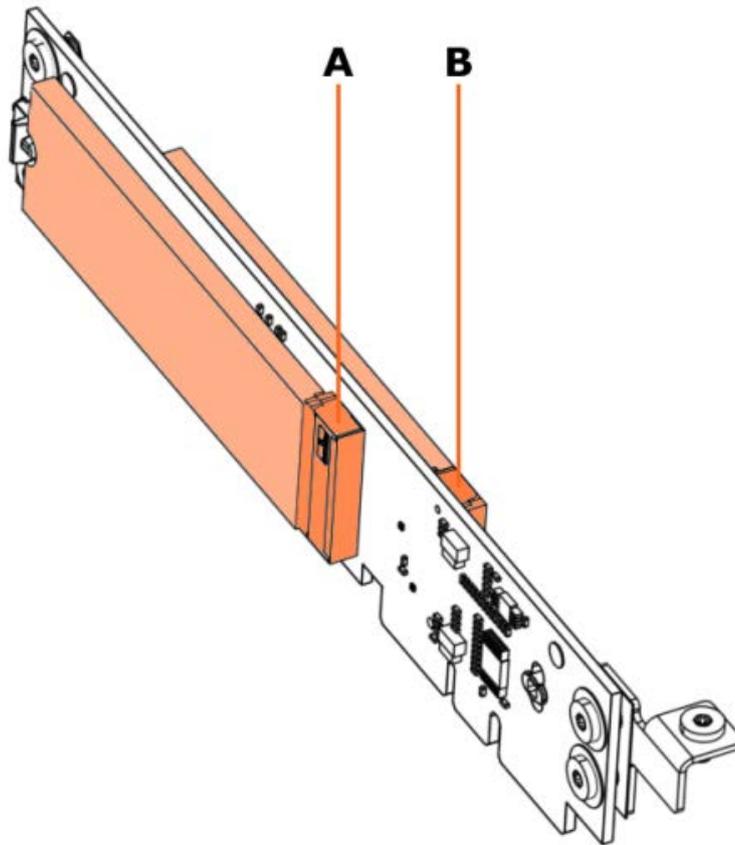


Mark	Slot	Possible card type
A	Slot 0 - M key connector	<ul style="list-style-type: none"> ▪ M.2 NVMe disk - M key (C) ▪ Accelerator card - B+M key (C)
B	Slot 1 - M key connector	<ul style="list-style-type: none"> ▪ M.2 NVMe disk - M key (C) ▪ Accelerator card - B+M key (C)
E	M.2 heat sink	N/A

Possible configurations

Slot	Configuration 1	Configuration 2	Configuration 3
M key connector	M.2 NVMe disk M key	Accelerator card B+M key	Accelerator card B+M key
M key connector	M.2 NVMe disk M key	Accelerator card B+M key	M.2 NVMe disk M key

M.2 type B riser board



Mark	Slot	Possible card types
A	Slot 0 - B key connector	<ul style="list-style-type: none"> ▪ LTE 5G ▪ Accelerator - B+M key
B	Slot 1 - E key connector	<ul style="list-style-type: none"> ▪ LoRa (using adaptor) ▪ WIFI + Bluetooth ▪ Accelerator - A+E key

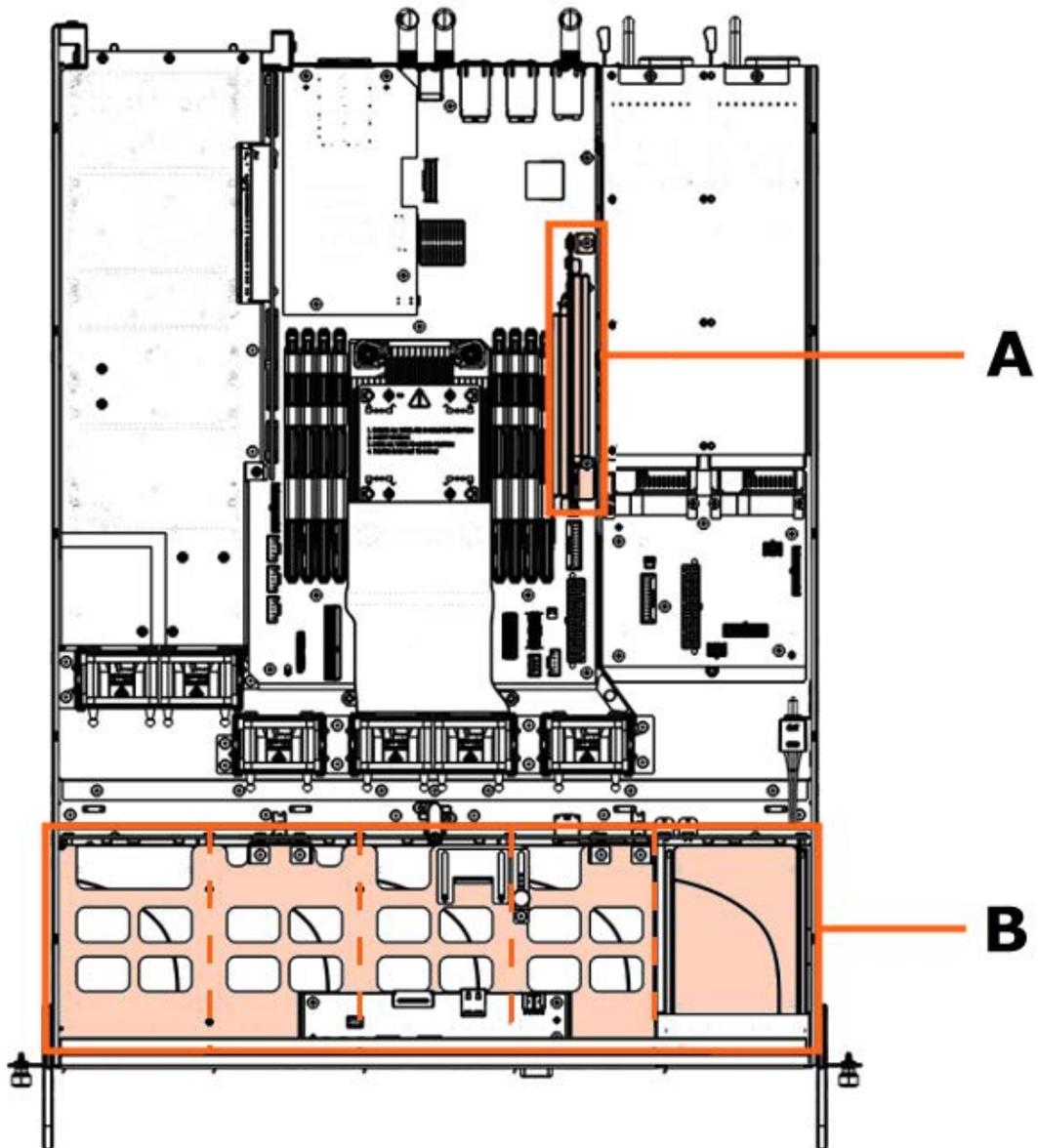
Possible configurations

Slot	Config 1	Config 2	Config 3	Config 4	Config 5
B key connector	LTE\5G	Accelerator card B+M key	LTE\5G	LTE\5G	Accelerator card B+M key
E key connector	WIFI + Bluetooth	WIFI + Bluetooth	Accelerator card A+E key	LoRa	LoRa

2.6. Storage

2.6.1. 2.5 inch SATA disk option

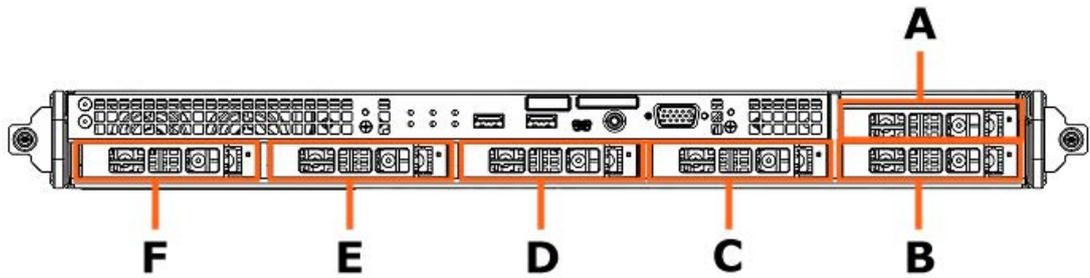
 Top view



Mark	Description	Quantity
A	M.2 NVMe disks	2
B	2.5 inch SATA disks	6

2.5 inch SATA disk slot numbering

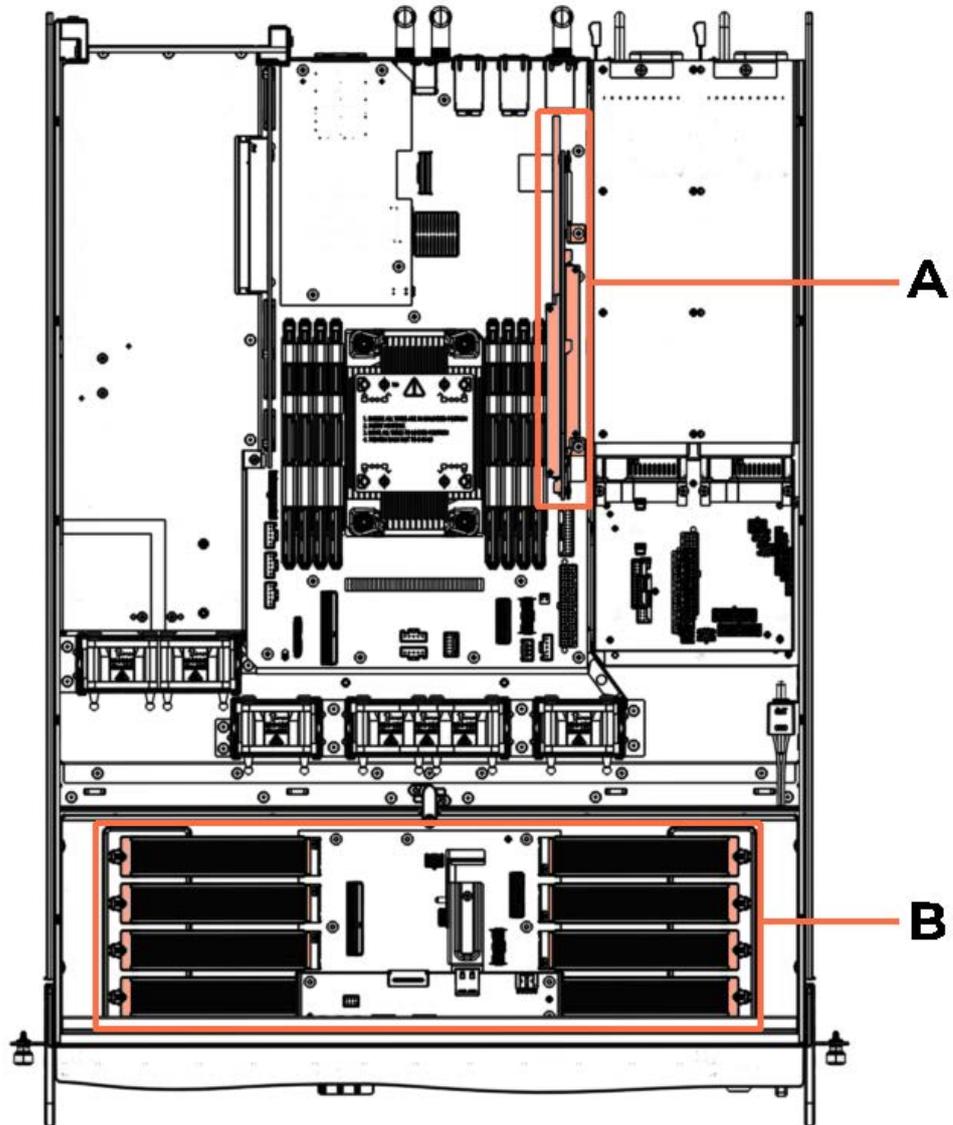
 Front view



Mark	Description
A	2.5 inch SATA disk slot 0
B	2.5 inch SATA disk slot 1
C	2.5 inch SATA disk slot 2
D	2.5 inch SATA disk slot 3
E	2.5 inch SATA disk slot 4
F	2.5 inch SATA disk slot 5

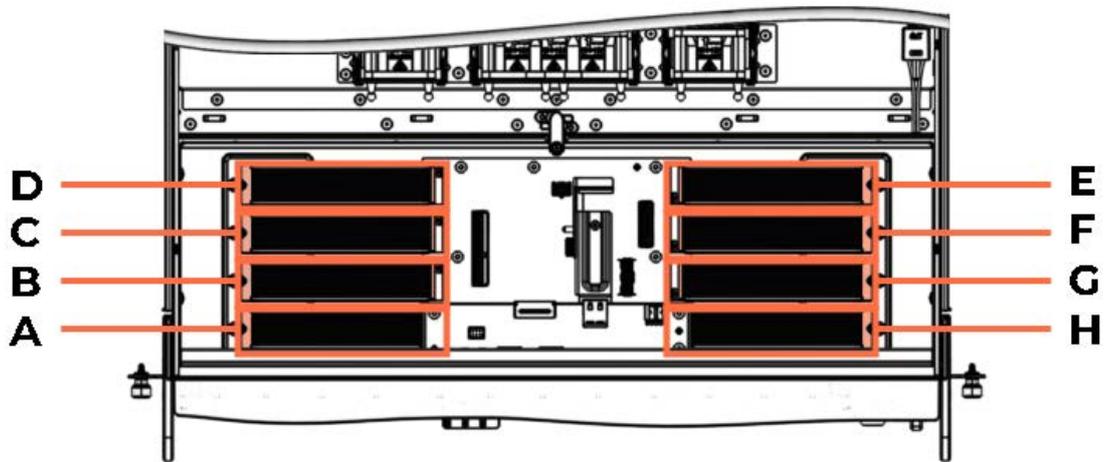
2.6.2. M.2 NVMe disk option

 Top view



Mark	Description	Quantity
A	M.2 NVMe disks	2
B	M.2 NVMe disks	Up to 8

M.2 NVMe disk slot numbering



Mark	Description
A	M.2 NVMe disk slot 0
B	M.2 NVMe disk slot 1
C	M.2 NVMe disk slot 2
D	M.2 NVMe disk slot 3
E	M.2 NVMe disk slot 4
F	M.2 NVMe disk slot 5
G	M.2 NVMe disk slot 6
H	M.2 NVMe disk slot 7

Note There are no disk in slots 6 and 7 on servers equipped with a 10 Gb/s mezzanine.

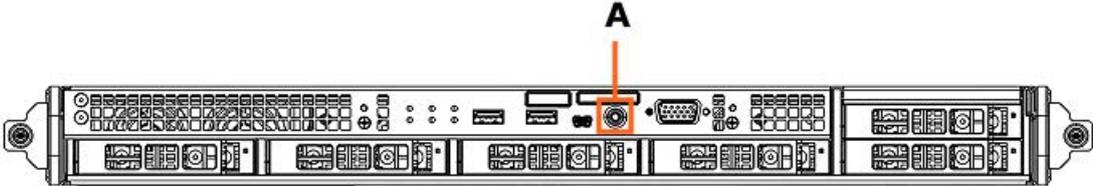
Chapter 3. Buttons, ports and LEDs

3.1. Front buttons, ports and LEDs

3.1.1. 2.5 inch SATA disk option

3.1.1.1. Buttons

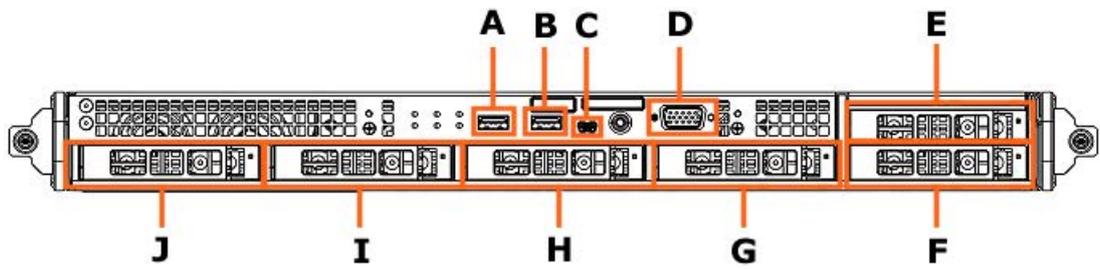
 Front view



Mark	Description
A	Power On / Off

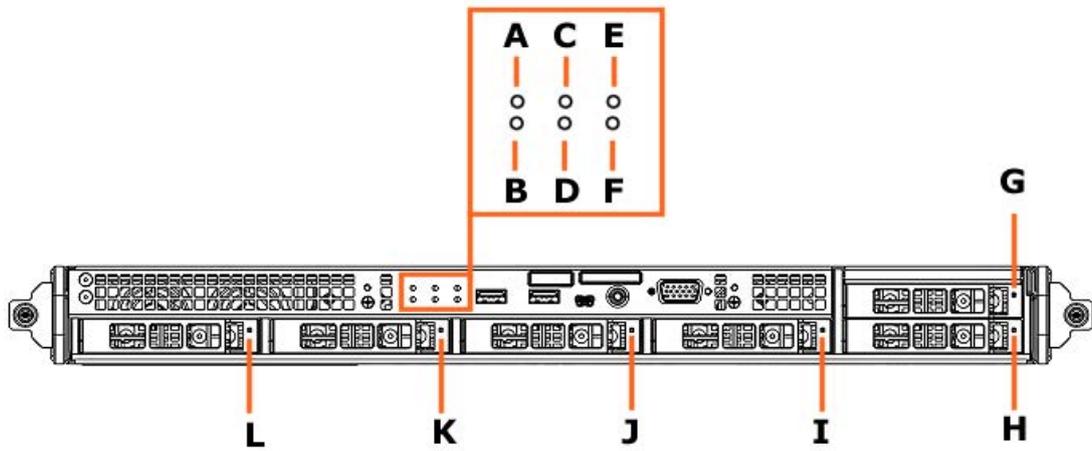
3.1.1.2. Ports

 Front view



Mark	Description	Port identification
A	USB 3.1 Type A connector	Port 1
B	USB 3.1 Type A connector	Port 0
C	USB 2.0 MiniType B connector	N/A
D	VGA connector	N/A
E	Disk slot	Slot 0
F	Disk slot	Slot 1
G	Disk slot	Slot 2
H	Disk slot	Slot 3
I	Disk slot	Slot 4
J	Disk slot	Slot 5

3.1.1.3. LEDs



Mark	LEDs	color	Description
A	Temperature fault	Green	OK
		Blinking red	Warning
		Red	Error
B	WDT fault	Green	OK
		Blinking red	Warning limit overdue
		Red	Error limit overdue
C	Fan fault	Green	OK
		Blinking red	Non critical error
		Red	Critical error / fault error
D	DIMM fault	Green	OK
		Blinking red	Warning
		Red	Error
E	Power	Green	Module power on status
		Blinking green	Module standby status
		Blinking red	Recovery mode
		Red	Power supply error
F	ID	Blinking blue	Module identification
G	SDD0	Blinking green	SATA activity
H	SDD1	Blinking green	SATA activity
I	SDD2	Blinking green	SATA activity

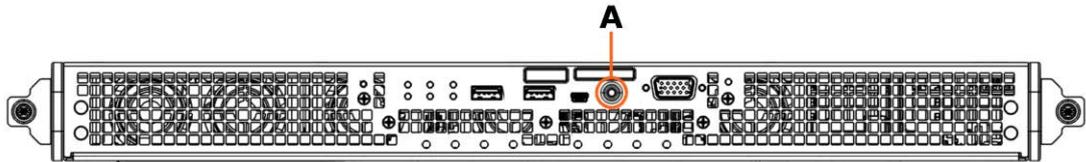
Mark	LEDs	color	Description
J	SDD3	Blinking green	SATA activity
K	SDD4	Blinking green	SATA activity
L	SDD5	Blinking green	SATA activity

3.1.2. M.2 NVMe disk option

3.1.2.1. Buttons



Front view

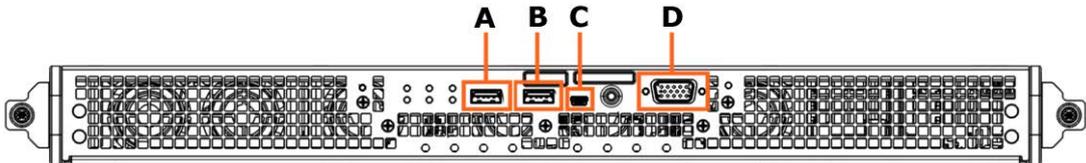


Mark	Description
A	Power On / Off

3.1.2.2. Ports

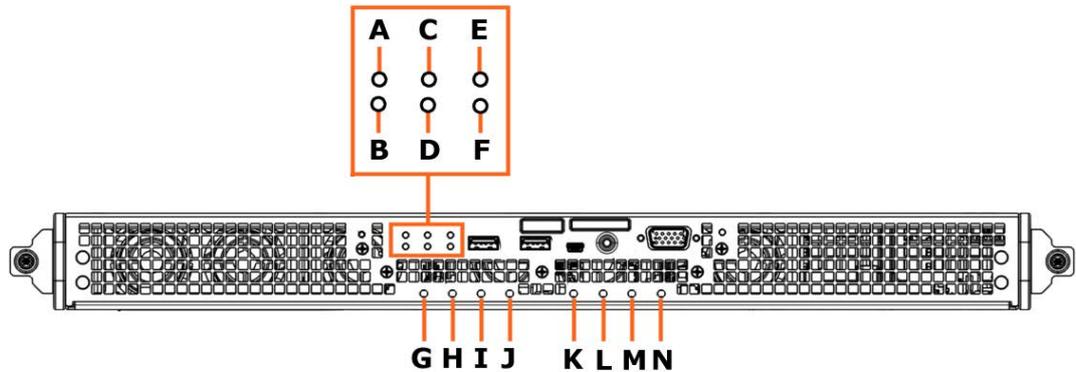


Front view



Mark	Description	Port identification
A	USB 3.1 Type A connector	Port 1
B	USB 3.1 Type A connector	Port 0
C	USB 2.0 Mini Type B connector	N/A
D	VGA connector	N/A

3.1.2.3. LEDs

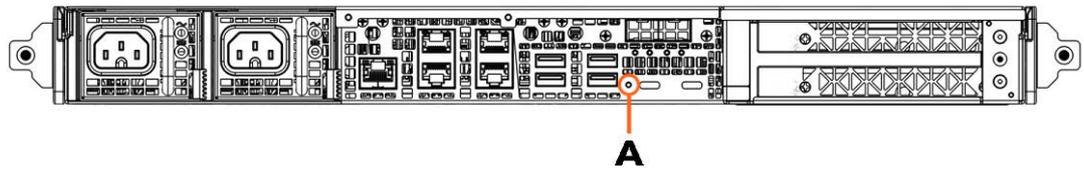


Mark	LEDs	Color	Description
A	Temperature fault	Green	OK
		Blinking red	Warning
		Red	Error
B	WDT (watch dog time) fault	Green	OK
		Blinking red	Warning limit overdue
		Red	Error limit overdue
C	Fan fault	Green	OK
		Blinking red	Non critical error
		Red	Critical error / fault error
D	DIMM fault	Green	OK
		Blinking red	Warning
		Red	Error
E	Power	Green	Module power on status
		Blinking green	Module standby status
		Blinking red	Recovery mode
		Red	Power supply error
F	ID	Blinking blue	Module identification
G	M.2 NVMe disk 0 activity	Blinking green	OK
		No LED	Fault / error or No AC power
H	M.2 NVMe disk 1 activity	Blinking green	OK
		No LED	Fault / error or No AC power

Mark	LEDs	Color	Description
I	M.2 NVMe disk 2 activity	Blinking green	OK
		No LED	Fault / error or No AC power
J	M.2 NVMe disk 3 activity	Blinking green	OK
		No LED	Fault / error or No AC power
K	M.2 NVMe disk4 activity	Blinking green	OK
		No LED	Fault / error or No AC power
L	M.2 NVMe disk 5 activity	Blinking green	OK
		No LED	Fault / error or No AC power
M	M.2 NVMe disk 6 activity	Blinking green	OK
		No LED	Fault / error or No AC power
N	M.2 NVMe disk 7 activity	Blinking green	OK
		No LED	Fault / error or No AC power

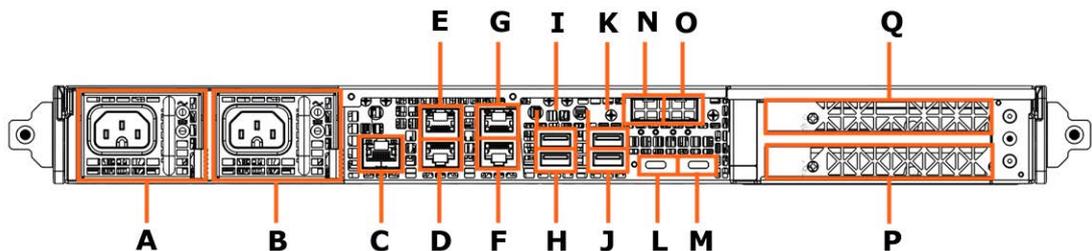
3.2. Rear buttons, ports and LEDs

3.2.1. Buttons



Mark	Function	Operation
A	BMC firmware recovery	Press the button in using a pointed object and release.
	Factory reset	Push the button in using a pointed object and hold it in for more than 10 seconds before releasing.

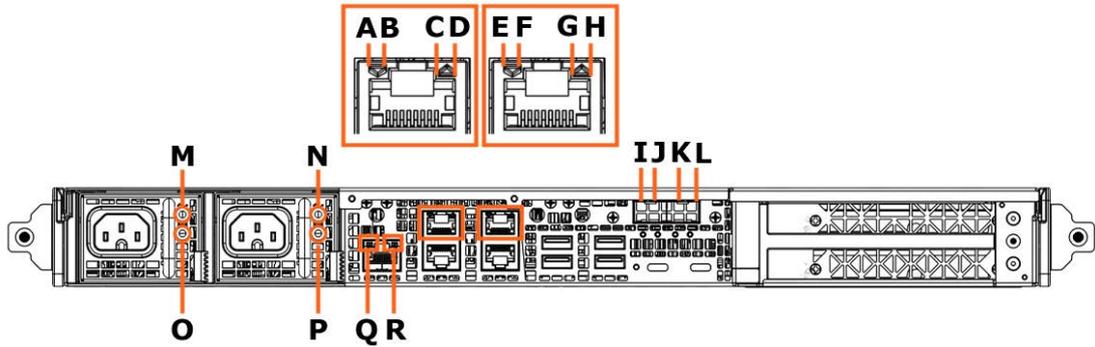
3.2.2. Ports



Mark	Description	Port identification
A	Power supply 0	PSU 0
B	Power supply 1	PSU 1
C	RJ45 - 1 Gb/s Ethernet LAN	BMC
D	RJ45 - 1 Gb/s Ethernet LAN	Port 0
E	RJ45 - 1 Gb/s Ethernet LAN	Port 1
F	RJ45 - 1 Gb/s Ethernet LAN	Port 2
G	RJ45 - 1 Gb/s Ethernet LAN	Port 3
H	USB 3.1 Type A	Port 0
I	USB 3.1 Type A	Port 1

Mark	Description	Port identification
J	USB 3.1 Type A	Port 2
K	USB 3.1 Type A	Port 3
L	USB 3.1 Type C	Port 0
M	USB 3.1 Type C	Port 1
N	SPF+ -10 Gb/s Ethernet (optional)	Port 0
O	SPF+ -10 Gb/s Ethernet (optional)	Port 1
P	x16 PCIe Riser	Slot 0
Q	x16 PCIe Riser	Slot 1

3.2.3. LEDs



Mark	LEDs	Color	Description
A	RJ45 port 0	Green	1 Gb/s Ethernet speed up
B	RJ45 port 0	Blinking amber	Ethernet link activity
C	RJ45 port 1	Green	1 Gb/s Ethernet speed up
D	RJ45 port 1	Blinking amber	Ethernet link activity
E	RJ45 port 2	Green	1 Gb/s Ethernet speed up
F	RJ45 port 2	Blinking amber	Ethernet link activity
G	RJ45 port 3	Green	1 Gb/s Ethernet speed up
H	RJ45 port 3	Blinking amber	Ethernet link activity
I	Mezzanine 10 Gb/s port 0	Green	1 Gb/s Ethernet speed up
J	Mezzanine 10 Gb/s port 0	Blinking amber	Ethernet link activity
K	Mezzanine 10 Gb/s port 1	Green	1 Gb/s Ethernet speed up
L	Mezzanine 10 Gb/s port 1	Blinking amber	Ethernet link activity
M	PSU 0 input LED	Green	OK. Input voltage within specified range
		Blinking green	OV/UV WARNING. Input voltage in overvoltage/undervoltage range
		No LED	OFF or FAULT. Input voltage above overvoltage range / below undervoltage range or not present

Mark	LEDs	Color	Description
N	PSU1 input LED	Green	OK. Input voltage within specified range
		Blinking green	OV/UV WARNING. Input voltage in overvoltage/undervoltage range
		No LED	OFF or FAULT. Input voltage above overvoltage range / below undervoltage range or not present
O	PSU0 output LED	Green	POWER GOOD. Both outputs operating normally; no warnings or faults
		Blinking green	STANDBY. Main output disabled via PS_ON signal; standby output operating normally (no warnings or faults)
		Blinking amber	WARNING. Power supply warning detected as per PMBus™ STATUS_X reporting bytes
		Amber	FAULT. Power supply fault detected as per PMBus™ STATUS_X reporting bytes
P	PSU1 output LED	Green	POWER GOOD. Both outputs operating normally; no warnings or faults
		Blinking green	STANDBY. Main output disabled via PS_ON signal; standby output operating normally (no warnings or faults)
		Blinking amber	WARNING. Power supply warning detected as per PMBus™ STATUS_X reporting bytes
		Amber	FAULT. Power supply fault detected as per PMBus™ STATUS_X reporting bytes
Q	RJ45 BMC	Green	1 gb/s Ethernet speed up
R	RJ45 BMC	Blinking amber	Ethernet link activity

Appendix A. Technical description

A.1. General technical specifications

Operating limits	
Ambient air temperature	0 °C to 45 °C; gradient 20 °C / hour
Relative humidity (non condensing)	5 % to 85 %; gradient 5 % / hour
Pressure	70 to 106 kPa
Elevation	Sea level < 3000 m
Non-operating limits	
Ambient air temperature	< -20 °C and > 60°C
Relative humidity (non condensing)	< 5 % and > 95 %; gradient 30 % / h
Moisture content	1 to 29 g / m ³
Shipping limits	
Operating air temperature	-20 °C to 60 °C ; gradient 25 °C / hour
Relative humidity (non condensing)	5 % to 95 %; gradient 30 % / hour

A.2. Dimensions and weight

BullSequana EXR & AI100R	
Height	1 U - 44 mm
Width	430 mm
Depth	550 mm
Weight	~ 15 kg

A.3. Module technical specifications

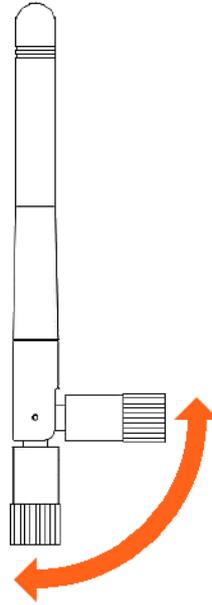
Electrical specifications	
Each BullSequana EXR & AI100R module is equipped with two redundant PSUs	
Rated Current	11 - 6 A
Power consumption	Typical: < 1000 W
Thermal dissipation	Maximum: 1100 W
Rated Voltage Range	100 - 240 VAC
Rated Frequency Range	50 / 60 Hz
Environmental specifications	
Noise	25 °C inlet, 75 % of worst TDP power : 75 dB
IP protection Class	IP 20 without front bezel / filter IP 40 with front bezel / filter

A.4. Server technical description

Processor	
Number	One processor per module
Type	Fourth generation Intel Xeon Scalable processors
Architecture	
Platform	Based on Intel Eagle Stream Platform
Memory	
Minimum / Maximum	Up to 1 TB
Type	DDR5 RDIMM Up to 4400 MT / s
Slots	Eight per module
I/O slots per module	
Bus slots	Two 16 Gen5 PCIe slots
I/O ports per module	
USB ports	Rear: six USB 3.1 Front: two USB 3.1
Ethernet ports	Two 10 Gb / s and five 1 Gb / s Ethernet ports
Disk bays per module	
Disks	Internal: two M.2 NVMe disks Storage: up to eight M.2 NVMe disks or six 2.5 inch SATA disks
GPUs per module	
GPUs	Up to two 150 W GPU cards or one 300 W GPU card

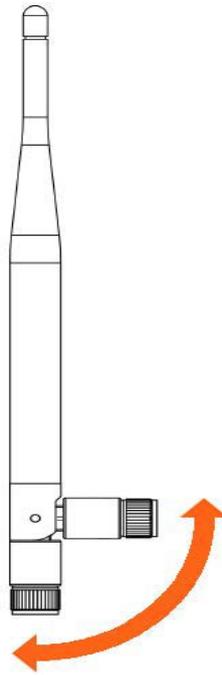
A.5. Antenna specifications

A.5.1. Dual-band WiFi



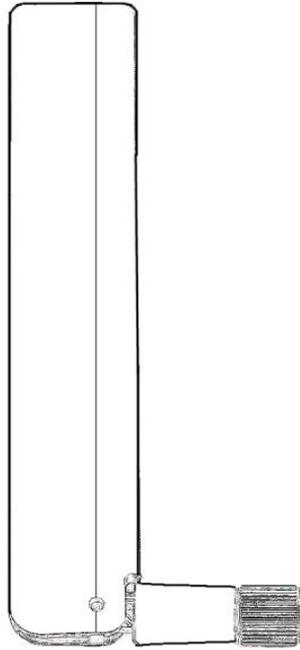
Dimensions	
Unfolded height	108 mm
Unfolded height	78 mm
Maximum width	10 mm
Minimum width	8 mm
Attached depth	31 mm
Technical specifications	
Frequency	2.4 - 5.9 GHz
Voltage Standing Wave Ratio	$\leq 2.5 : 1$
Gain	2.5 dB
Polarization	Vertical
Impedance	50 Ω
Max power	20 W
Environmental characteristics	
Operating temperature	- 40°C to + 85°C
Compliance	RoHS compliant

A.5.2. LoraWAN



Dimensions	
Unfolded height	197 ± 3 mm
Unfolded height	173 ± 2 mm
Maximum width	13 mm
Minimum width	6 mm
Attached depth	37.3 ± 0.5 mm
Technical specifications	
Frequency	868 MHz
Voltage Standing Wave Ratio	< 2.0
Gain	3 dBi
Polarization	Linear
Impedance	50 Ω
Max power	20 W
Environmental characteristics	
Operating temperature	- 40°C to + 85°C
Vibration	10 to 55 Hz with 1.5 mm amplitude 2 hours
Compliance	RoHS compliant

A.5.3. LTE / 5G



Dimensions			
Height	135 mm		
Width	10 mm		
Attached depth	19 mm		
Technical specifications			
Frequency (MHz)	617-960	1427-2690	3300-5000
Voltage Standing Wave Ratio	~2.0:1	~2.6:1	~2.3:1
Peak gain (dBi)	~-1.1	~0.5	~0.3
Average gain (dB)	~-4.3	~-3.8	~-4.6
Polarization	Linear		
Impedance	50 Ω		
Max power	25 W		
Environmental characteristics			
Operating temperature	- 40°C to + 85°C		
Compliance	RoHS compliant		

Acronyms

A

No entries

B

BIOS

Basic Input / Output System

BMC

Baseboard Management Controller

C

CPU

Central Processing Unit

CRU

Customer Replaceable Unit

D

DDR5

Double Data Rate fifth generation

DIMM

Dual In-line Memory Module

E

No entries

F

FPB

Front Panel Board

FPGA

Field Programmable Gate Array

FRU

Field Replaceable Unit

G

GPU

Graphical Processing Unit

GSM

Global System for Mobile communications

H

HTTPS

HyperText Transfer Protocol Secure

I

IP

Internet Protocol

J

No entries

K

No entries

L

LAN

Local Area Network

LED

Light Emitting Diode

LoRa

Long Range wireless communication

LoRaWAN

Long Range Wide Area Network

LTE

Long Term Evolution

M

MAC

Media Access Control

MI

Machine Intelligence

MISM

Machine Intelligence System Management

MIPSE

Machine Intelligence Pocket Server

N

NVMe

Non-Volatile Memory express

O

No entries

P

PDB

Power Distribution Board

PCI

Peripheral Component Interconnect

PCIe

PCI Express

PDU

Power Distribution Unit

PSU

Power Supply Unit

Q

No entries

R

RDIMM

Registered Dual In-line Memory Module

REST

Representational State Transfert

S

SATA

Serial ATA

SEL

System Event Log

SSD

Solid State Drive

SSH

Secured Shell

SSL

Secure Socket Layer

T

TDP

Thermal Design Point

U

USB

Universal Serial Bus

V**VGA**

Video Graphic Array

W**WIFI**

Wireless Fidelity

WDT

Watch Dog Timer

X

No entries

Y

No entries

Z

No entries

